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PATENTO SER

U.S. **UTILITY** Patent Application

7.5. OTILITY Fatent Applic	cation
SCANNED CO.I.P.E.	PATENT DATE

APPLICATION NO. | CONT/PRIOR | CLASS | SUBCLASS | ART UNIT | EXAMINER | 1723 | CH

James Kipp Joseph Tak Wong Mark Doty Christine Rebbeck

Microprecipitation method for preparing submicron suspensions

TITLE

12/99

Ĺ	ISSUING CLASSIFICATION														
ORIGINAL				CROSS REFERENCE(S)											
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TERMINAL DISCLAIMER		DRAWINGS		CLAIMS ALLOWED		
DISCLAIMEN	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.	
The term of this patent subsequent to(date)				NOTICE OF ALLOWANCE MAILED		
has been disclaimed.	(Assistant E	Examiner)	(Date)			
The term of this patent shall not extend beyond the expiration date						
of U.S Patent. No.				ISSUE FEE		
				Amount Due	Date Paid	
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The terminalmonths of this patent have been disclaimed.				ISSUE BAT	CH NUMBER	
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